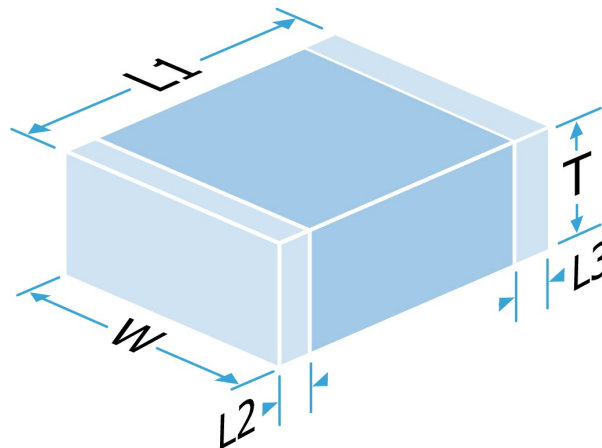


Multilayer Ceramic Chip Capacitor

Part Number: 222523K63P30BQTAF9LM

Description: 2225 3600Vdc / 2500Vac 30MHz 3.3pF
±0.10pF C0G - Hi Q/Low ESR Non-Mag (PME)

Ultra stable HighQ Low ESR multi-layer ceramic capacitors offering very stable $0 \pm 30 \text{ppm}/^\circ\text{C}$, $0 \pm 15 \text{ppm}/^\circ\text{C}$ or $+90 \pm 20 \text{ppm}/^\circ\text{C}$ High Q material systems that provide excellent low loss performance and guaranteed non-magnetic / relative permeability of 1.000 for critical applications such as NMR / MRI. Optimised for the lowest possible ESR and with maximised voltage ratings, this range provides the best possible conduction of high power RF signals.



Mechanical Specification

Size Code	2225
Length (L1) in mm (")	5.7 ± 0.40 (0.225 ± 0.016)
Width (W) in mm (")	6.30 ± 0.40 (0.252 ± 0.016)
Thickness (T) in mm (")	4.0 Max (0.157 Max)
Minimum Termination Band (L2,L3) in mm (")	0.25 (0.010)
Maximum Termination Band (L2,L3) in mm (")	1.00 (0.040)
Termination Material	Copper Barrier, Sn Plated Solder (Non-Mag., RoHS compliant)
Solderability	IEC-60068-2-58
Packaging	7" Reel Horizontal Orientation, 500 per reel

General Electrical Specification

Rated Voltage	3600Vdc / 2500Vac 30MHz
Nominal Capacitance Value	3.3pF
Capacitance Tolerance	±0.10pF
Tangent of Loss Angle (Tan δ)	≤0.0014
Capacitance and Tan δ Test Conditions	1.0Vrms @ 1MHz
Voltage Proof	4320Vdc
(Voltage applied for 5 secs max. @ 50mA max. charge current)	
Min Insulation Resistance (IR)	100.00GOhm @ 100Vdc
Dielectric Classification	C0G - Hi Q/Low ESR Non-Mag (PME)
Rated Temperature Range	-55°C / +125°C
Maximum Capacitance Change over Temperature Range	No DC Voltage $0 \pm 30 \text{ppm}/^\circ\text{C}$ Rated DC Voltage -
Climatic Category (IEC)	55/125/56
Ageing Characteristic	Zero

Knowles Precision Devices - Sales

Europe: KPD-Europe-sales@knowles.com

Asia: KPD-Asia-sales@knowles.com

USA: KPD-NA-sales@knowles.com

www.knowlescapacitors.com

This datasheet is for a standard item and is confirmed valid on the date generated, the latest published data for this part may differ and is available at <http://www.knowlescapacitors.com> or by contacting us.

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Data is correct to the best of our knowledge, errors and omissions excepted.

Date: Monday, February 07, 2022

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Multilayer Ceramic Chip Capacitor

Part Number: 222523K63P30BQTAF9LM

Description: 2225 3600Vdc / 2500Vac 30MHz 3.3pF
±0.10pF C0G - Hi Q/Low ESR Non-Mag
(PME)

Environmental

RoHS Compliant to 2011/65/EC as amended by 2015/863/EU

Compliant

REACH Compliant

219 compliant

California Proposition 65

No exposure risk

Board Layout

Knowles' conventional 2-terminal chip capacitors can generally be mounted using pad designs in accordance with international specification IPC-7351, Generic Requirements for Surface Mount Design and Land Pattern Standards, but there are some other factors that have been shown to reduce mechanical stress, such as reducing the pad width to less than the chip width. In addition, the position of the chip on the board should be considered.

Some high voltage parts may require modifications to the board layout and/or the addition of a conformal coating to prevent flashover. Refer to application note AN0043 for further information.

IPC-7351 pad design

	2225	
C	5.20mm	0.205"
Y	1.65mm	0.065"
X	6.70mm	0.264"



Packaging

Tape packaging information for tape-and-reel parts:

Tape and reel packing of surface mounting chip capacitors for automatic placement are in accordance with IEC60286-3.



Soldering

Reflow solder in accordance with IPC-A-610. Recommended reflow profile as laid down in IPC/JEDEC J-STD-020.

Wave soldering is also possible, but care must be taken for case sizes 1210 and larger and component thickness >1.0mm. Trials are encouraged.

Hand soldering is not recommended and can lead to component damage through thermal shock.

PdAg terminations are primarily intended for conductive epoxy attachment - they may be suitable for soldering but trials are recommended.

Application notes with mounting and handling guidance are available on request.



Compex

DLI

Johanson MFG

Novacap

Syfer

Voltronics

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